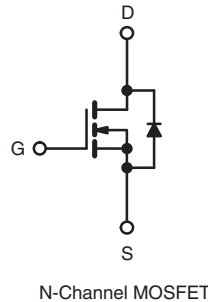
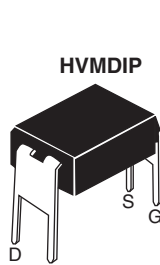


## Power MOSFET

PRODUCT SUMMARY		
$V_{DS}$ (V)	100	
$R_{DS(on)}$ ( $\Omega$ )	$V_{GS} = 5.0$ V	0.54
$Q_g$ (Max.) (nC)	6.1	
$Q_{gs}$ (nC)	2.6	
$Q_{gd}$ (nC)	3.3	
Configuration	Single	



### FEATURES

- Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- For Automatic Insertion
- End Stackable
- Logic-Level Gate Drive
- $R_{DS(on)}$  Specified at  $V_{GS} = 4$  V and 5 V
- 175 °C Operating Temperature
- Material categorization: For definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)


 Available  
**RoHS\***  
 COMPLIANT

### Note

\* Lead (Pb)-containing terminations are not RoHS-compliant. Exemptions may apply.

### DESCRIPTION

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The 4 pin DIP package is a low cost machine-insertable case style which can be stacked in multiple combinations on standard 0.1" pin centers. The dual drain serves as a thermal link to the mounting surface for power dissipation levels up to 1 W.

ORDERING INFORMATION	
Package	HVMDIP
Lead (Pb)-free	IRLD110PbF
	SiHLD110-E3
SnPb	IRLD110
	SiHLD110

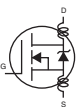

ABSOLUTE MAXIMUM RATINGS ( $T_A = 25$ °C, unless otherwise noted)				
PARAMETER	SYMBOL	LIMIT	UNIT	
Drain-Source Voltage	$V_{DS}$	100	V	
Gate-Source Voltage	$V_{GS}$	$\pm 10$		
Continuous Drain Current	$V_{GS}$ at 5.0 V	$T_A = 25$ °C	A	
		$T_A = 100$ °C		
Pulsed Drain Current <sup>a</sup>	$I_{DM}$	8.0		
Linear Derating Factor		0.0083	W/°C	
Single Pulse Avalanche Energy <sup>b</sup>	$E_{AS}$	100	mJ	
Avalanche Current <sup>a</sup>	$I_{AR}$	1.0	A	
Repetitive Avalanche Energy <sup>a</sup>	$E_{AR}$	0.13	mJ	
Maximum Power Dissipation	$T_A = 25$ °C	$P_D$	1.3	W
Peak Diode Recovery dV/dt <sup>c</sup>	dV/dt	5.5	V/ns	
Operating Junction and Storage Temperature Range	$T_J, T_{stg}$	- 55 to + 175	°C	
Soldering Recommendations (Peak Temperature)	for 10 s	300 <sup>d</sup>		

### Notes

- Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- $V_{DD} = 25$  V, starting  $T_J = 25$  °C,  $L = 6.4$  mH,  $R_g = 25$   $\Omega$ ,  $I_{AS} = 5.6$  A (see fig. 12).
- $I_{SD} \leq 5.6$  A,  $di/dt \leq 75$  A/ $\mu$ s,  $V_{DD} \leq V_{DS}$ ,  $T_J \leq 175$  °C.
- 1.6 mm from case.



THERMAL RESISTANCE RATINGS				
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum Junction-to-Ambient	$R_{thJA}$	-	120	$^{\circ}C/W$

SPECIFICATIONS ( $T_J = 25^{\circ}C$ , unless otherwise noted)							
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
<b>Static</b>							
Drain-Source Breakdown Voltage	$V_{DS}$	$V_{GS} = 0 V, I_D = 250 \mu A$		100	-	-	V
$V_{DS}$ Temperature Coefficient	$\Delta V_{DS}/T_J$	Reference to $25^{\circ}C, I_D = 1 mA$		-	0.12	-	$V/^{\circ}C$
Gate-Source Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250 \mu A$		1.0	-	2.0	V
Gate-Source Leakage	$I_{GSS}$	$V_{GS} = \pm 10 V$		-	-	$\pm 100$	nA
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS} = 100 V, V_{GS} = 0 V$		-	-	25	$\mu A$
		$V_{DS} = 80 V, V_{GS} = 0 V, T_J = 150^{\circ}C$		-	-	250	
Drain-Source On-State Resistance	$R_{DS(on)}$	$V_{GS} = 5.0 V$	$I_D = 0.60 A^b$	-	-	0.54	$\Omega$
		$V_{GS} = 4.0 V$	$I_D = 0.50 A^b$	-	-	0.76	
Forward Transconductance	$g_{fs}$	$V_{DS} = 50 V, I_D = 0.60 A^b$		1.3	-	-	S
<b>Dynamic</b>							
Input Capacitance	$C_{iss}$	$V_{GS} = 0 V,$ $V_{DS} = 25 V,$ $f = 1.0 MHz, \text{ see fig. 5}$		-	250	-	$\mu F$
Output Capacitance	$C_{oss}$			-	80	-	
Reverse Transfer Capacitance	$C_{rss}$			-	15	-	
Total Gate Charge	$Q_g$	$V_{GS} = 5.0 V$	$I_D = 5.6 A, V_{DS} = 80 V,$ $\text{ see fig. 6 and 13}^b$	-	-	6.1	nC
Gate-Source Charge	$Q_{gs}$			-	-	2.6	
Gate-Drain Charge	$Q_{gd}$			-	-	3.3	
Turn-On Delay Time	$t_{d(on)}$	$V_{DD} = 50 V, I_D = 5.6 A,$ $R_g = 12 \Omega, R_D = 8.4 \Omega, \text{ see fig. 10}^b$		-	9.3	-	ns
Rise Time	$t_r$			-	4.7	-	
Turn-Off Delay Time	$t_{d(off)}$			-	16	-	
Fall Time	$t_f$			-	17	-	
Internal Drain Inductance	$L_D$	Between lead, 6 mm (0.25") from package and center of die contact 		-	4.0	-	nH
Internal Source Inductance	$L_S$			-	6.0	-	
<b>Drain-Source Body Diode Characteristics</b>							
Continuous Source-Drain Diode Current	$I_S$	MOSFET symbol showing the integral reverse p - n junction diode 		-	-	1.0	A
Pulsed Diode Forward Current <sup>a</sup>	$I_{SM}$			-	-	8.0	
Body Diode Voltage	$V_{SD}$	$T_J = 25^{\circ}C, I_S = 1.0 A, V_{GS} = 0 V^b$		-	-	2.5	V
Body Diode Reverse Recovery Time	$t_{rr}$	$T_J = 25^{\circ}C, I_F = 5.6 A, di/dt = 100 A/\mu s^b$		-	110	130	ns
Body Diode Reverse Recovery Charge	$Q_{rr}$			-	0.50	0.65	$\mu C$
Forward Turn-On Time	$t_{on}$	Intrinsic turn-on time is negligible (turn-on is dominated by $L_S$ and $L_D$ )					

**Notes**

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. Pulse width  $\leq 300 \mu s$ ; duty cycle  $\leq 2 \%$ .



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

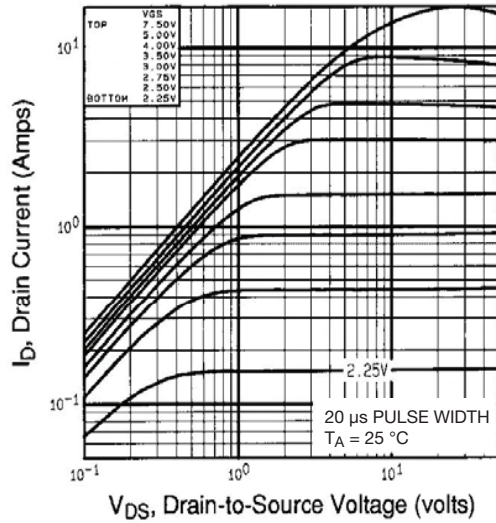


Fig. 1 - Typical Output Characteristics,  $T_A = 25\text{ }^\circ\text{C}$

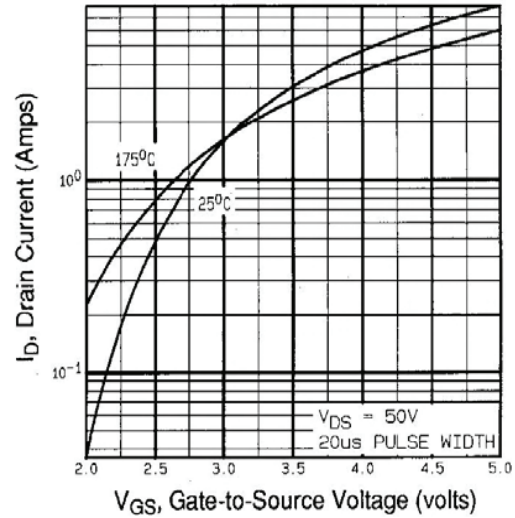


Fig. 3 - Typical Transfer Characteristics

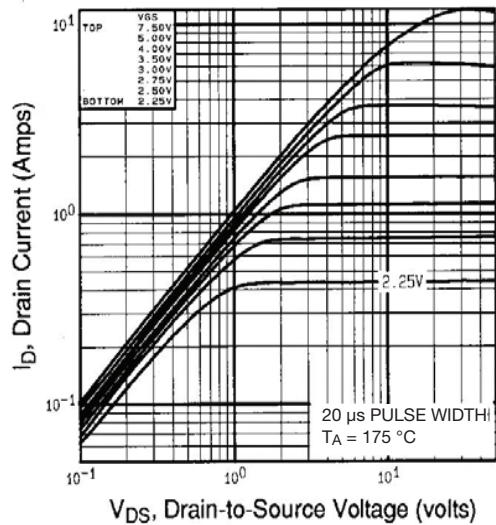


Fig. 2 - Typical Output Characteristics,  $T_A = 175\text{ }^\circ\text{C}$

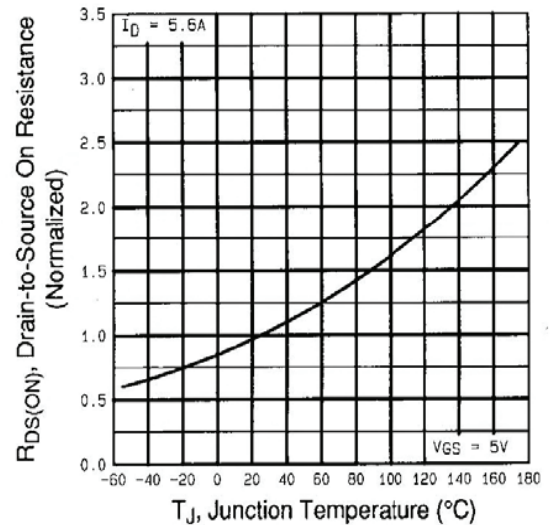


Fig. 4 - Normalized On-Resistance vs. Temperature

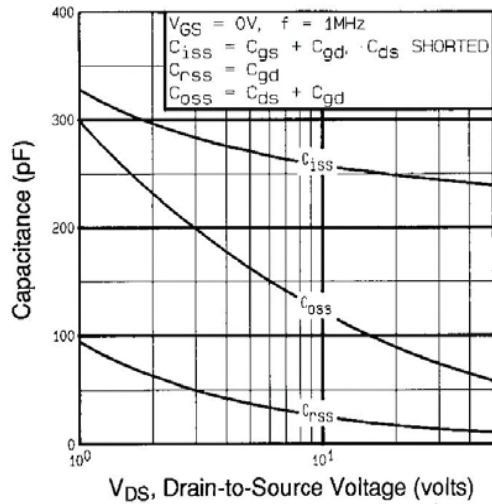


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

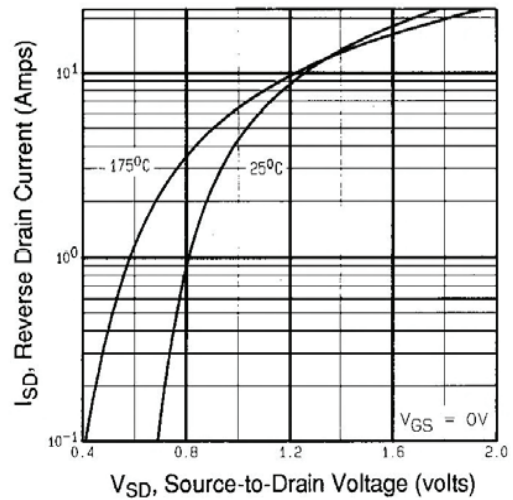


Fig. 7 - Typical Source-Drain Diode Forward Voltage

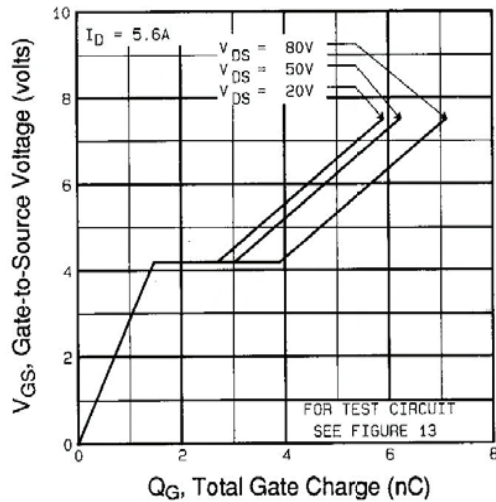


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

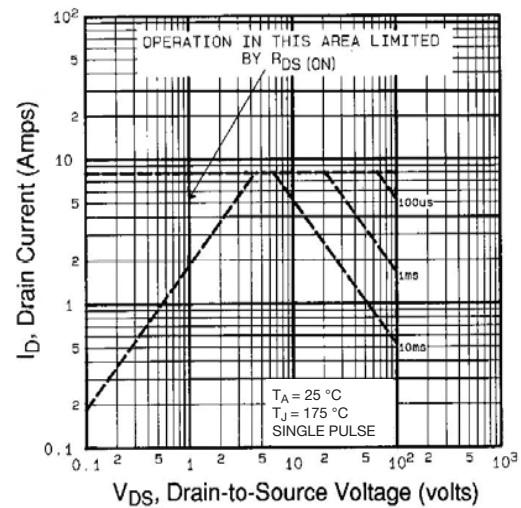


Fig. 8 - Maximum Safe Operating Area

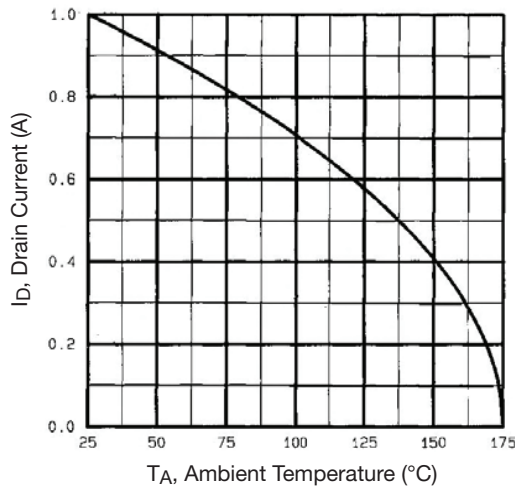


Fig. 9 - Maximum Drain Current vs. Ambient Temperature

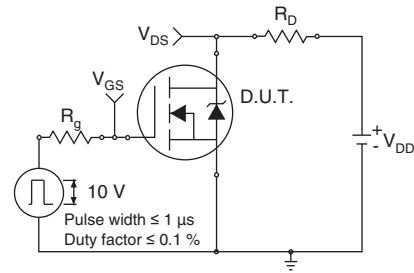


Fig. 10 - Switching Time Test Circuit

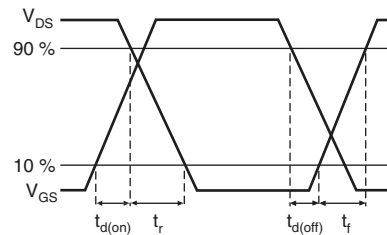


Fig. 11 - Switching Time Waveforms

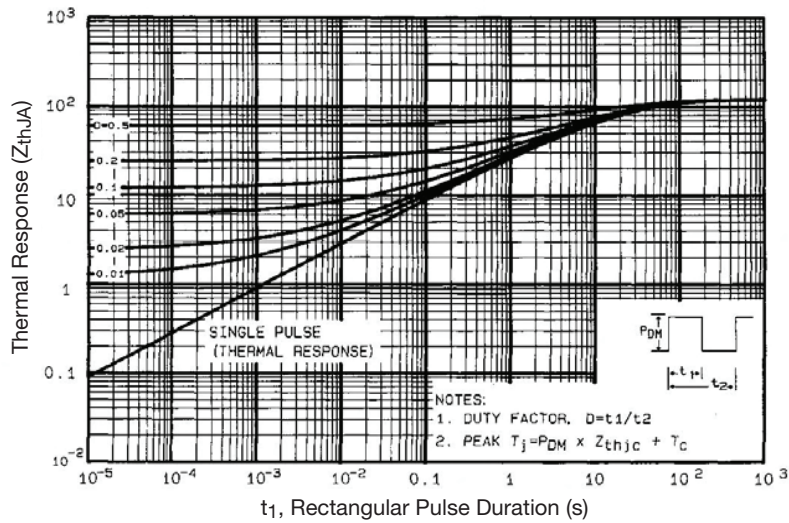


Fig. 12 - Maximum Effective Transient Thermal Impedance, Junction-to-Ambient

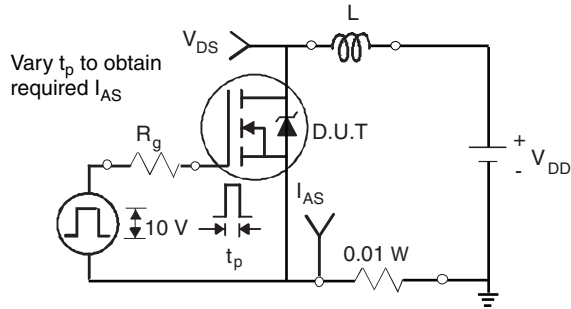


Fig. 13 - Unclamped Inductive Test Circuit

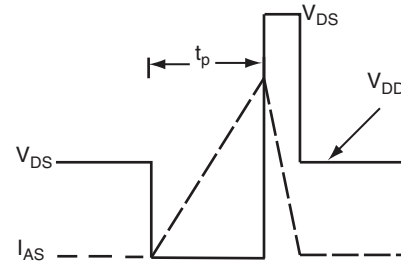


Fig. 14 - Unclamped Inductive Waveforms

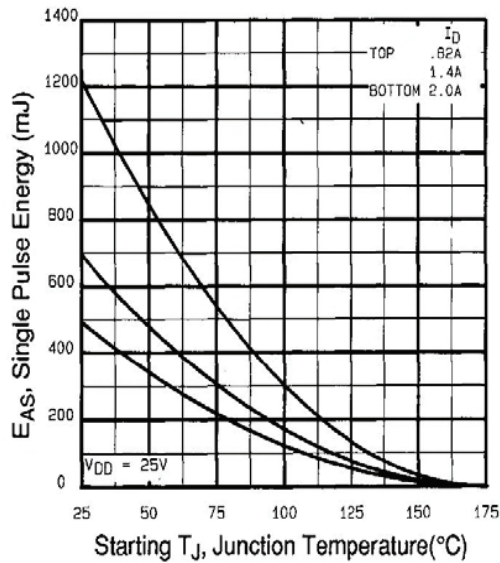


Fig. 15 - Maximum Avalanche Energy vs. Drain Current

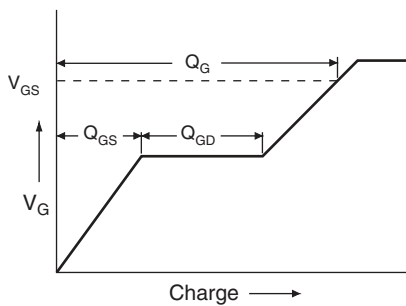


Fig. 16 - Basic Gate Charge Waveform

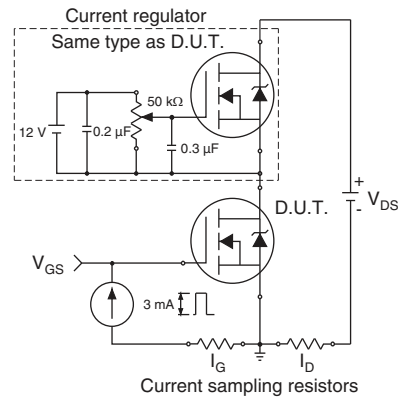
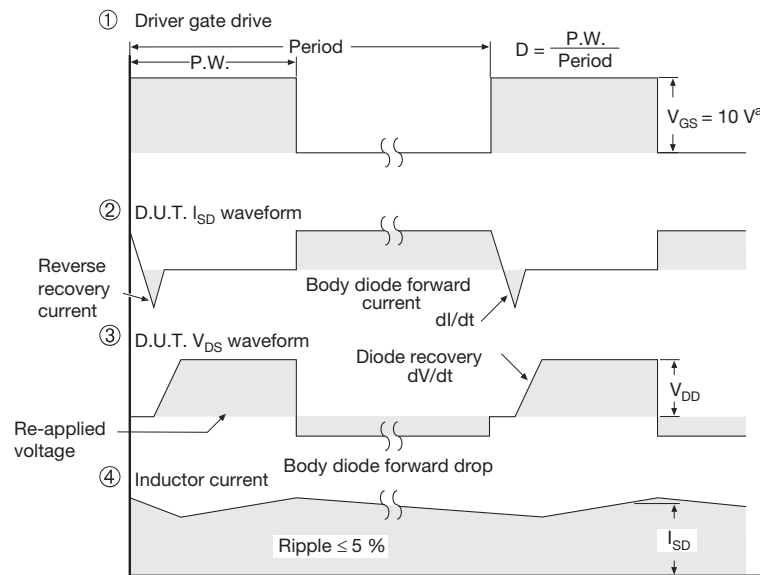
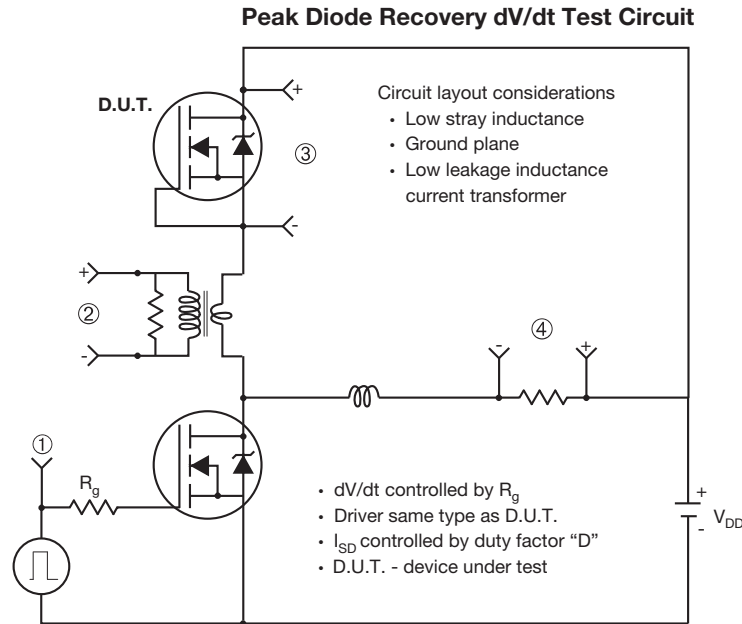


Fig. 17 - Gate Charge Test Circuit





**Note**

a.  $V_{GS} = 5 V$  for logic level devices

**Fig. 18 - For N-Channel**

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## HVM DIP (High voltage)



DIM.	INCHES		MILLIMETERS	
	MIN.	MAX.	MIN.	MAX.
A	0.310	0.330	7.87	8.38
E	0.300	0.425	7.62	10.79
L	0.270	0.290	6.86	7.36

ECN: X10-0386-Rev. B, 06-Sep-10  
DWG: 5974

### Note

- Package length does not include mold flash, protrusions or gate burrs. Package width does not include interlead flash or protrusions.





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Web: <http://oceanchips.ru/>

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